

Product Change Notification / RMES-19ZBNI141

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Asse	mbly Site	UTAC Thai Limited (NSEB)	UTAC Thai Limited (NSEB)					
Wire	Material	Au	Au					
Die Atta	ach Material	HR-5104 (DAF)	HR-5104 (DAF)					
Molding Cor	mpound Material	G700LTD	G700LTD					
	Material	EFTEC-64T	EFTEC-64T					
	iviateriai	See Pre and Post Change Summary for comparison						
Lead Frame	Inner Lead Plating	NiPdAu	Ag					
Loud Framo	(Bond Finger)	(Pd Custom Plating)	(Ag on lead only)					
	Lead Finish Plating	Matte Tin	Matte Tin					

Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve productivity by qualifying Ag on lead (Inner Lead Plating) material.

Change Implementation Status:In Progress

Estimated First Ship Date:March 15, 2022 (date code: 2212)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	May 2021				>	February 2022			March 2022						
Workweek	1 9	2	2 1	2 2	2 3		0 6	0 7	0 8	0 9	1 0	1 1	1 2	1 3	1 4
Initial PCN Issue Date				Χ											
Qual Report Availability									Χ						
Final PCN Issue Date									Χ						
Estimated Implementation Date													Χ		

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:May 28, 2021: Issued initial notification.

February 14, 2022: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on March 15, 2022.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_RMES-19ZBNI141_Qual_Report.pdf PCN_RMES-19ZBNI141_Pre and Post Change Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

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If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

RMES-19ZBNI141-CCB~4685~Final~Notice: Qualification~of~Ag~on~lead~(Inner~Lead~Plating)~material~for~selected~SST26WF080B~and~SST26WF040B~device~families~available~in~8L~UDFN~(2x3x0.55mm)~package.

Affected Catalog Part Numbers (CPN)

SST26WF080BT-104I/NP SST26WF080BAT-104I/NP SST26WF040BT-104I/NP SST26WF040BAT-104I/NPINTC

Date: Monday, February 14, 2022